

GESMD5050RGB

Datasheet



Features :

- High Luminous Intensity
- Based on Blue/Green : InGaN, Red : AlGaInP technology
- Wide viewing angle : 120°
- Excellent performance and visibility
- Suitable for all SMT assembly methods
- IR reflow process compatible
- Environmental friendly; RoHS compliance

Typical Applications :

- Signal and Symbol Luminaire
- Indoor and Outdoor Displays
- Backlighting (illuminated advertising, general lighting)
- Interior Automotive Lighting

Absolute Maximum Ratings

Absolute maximum ratings (T_a=25°C)

Parameter	Symbol	Value	Units
DC Forward Current	(R) (T/B) I _F	35 30	mA
Pulse Forward Current (tp≤100μs, Duty cycle=0.25)	I _{pulse}	80 100	mA
Reverse Voltage	V _R	5	V
LED Junction Temperature	T _J	115	°C
Operating Temperature	-	-40 ~ +85	°C
Storage Temperature	-	-40 ~ +125	°C
ESD Sensitivity (HBM)	V _B	2,000	V
Soldering Temperature	T _s	Reflow Soldering : 255~260°C/10~30sec Manual Soldering : 350°C/3sec	

Notes:

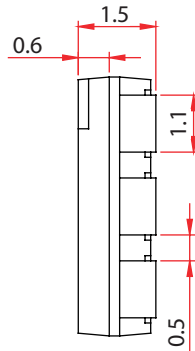
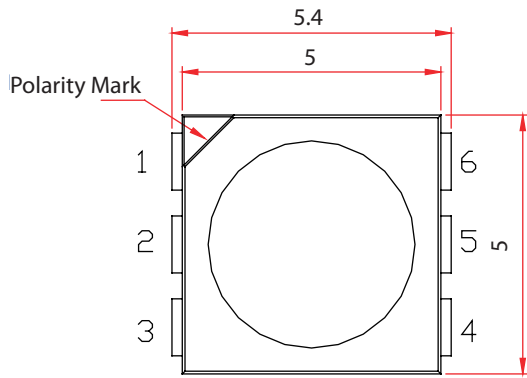
- The values are based on 1-die performance.
- * I_{FP} condition: pulse width ≤0.1msec and duty ≤1/10.

Electronic optical Parameters

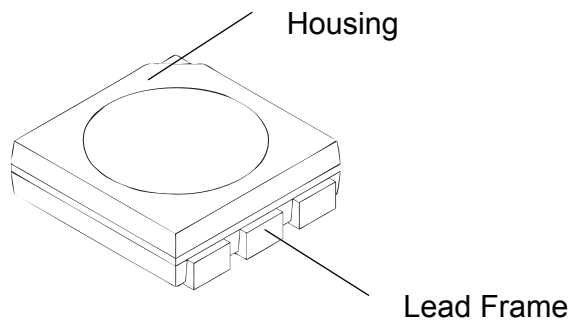
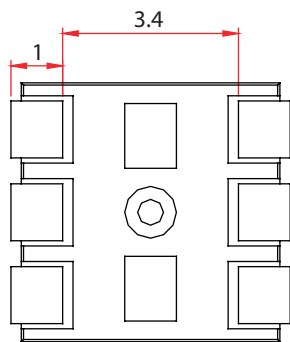
Electronic-Optical Characteristics (T _a =25°C, I _f =20mA)				M/N: GESMD5050RGB			
Parameter	Test condition	Symbol	Color	Value			Unit
				Min	Typ	Max	
Wavelength	I _f =20mA	λ	R	620	625	630	nm
			G	520	525	530	nm
			B	460	465	470	nm
Forward Voltage	I _f =20mA	V _F	R	1.8	2.0	2.2	V
			G	3.0	3.2	3.4	V
			B	3.0	3.2	3.4	V
Luminous Intensity	I _f =20mA	I _v	R	600	640	720	mcd
			G	1500	1650	1800	mcd
			B	400	450	500	mcd
View angle	I _f =20mA	θ		120		Deg	
Reverse current	I _f =20mA	I _r		10		uA	

Mechanical Dimensions

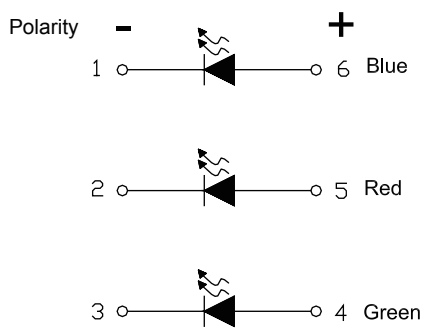
Emitter Type Dimension



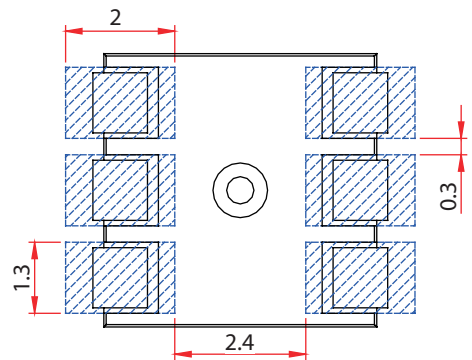
Unit: mm
Tolerance: ± 0.2 mm



Circuit



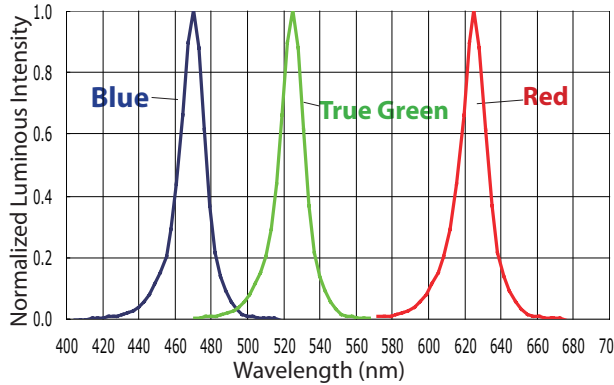
Solder Pad



- Notes:
1. All dimensions are measured in mm.
 2. Tolerance : ± 0.2 mm

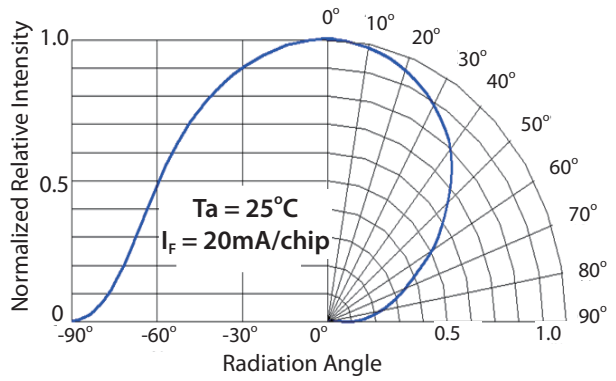
Characteristic Curve

Color Spectrum



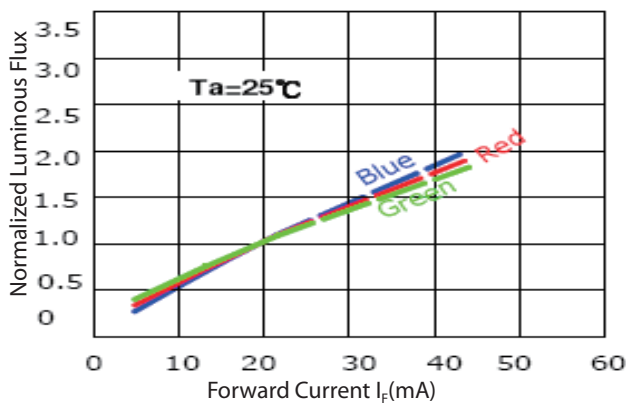
Color Spectrum for PLCC 5050 series

Radiation Diagram



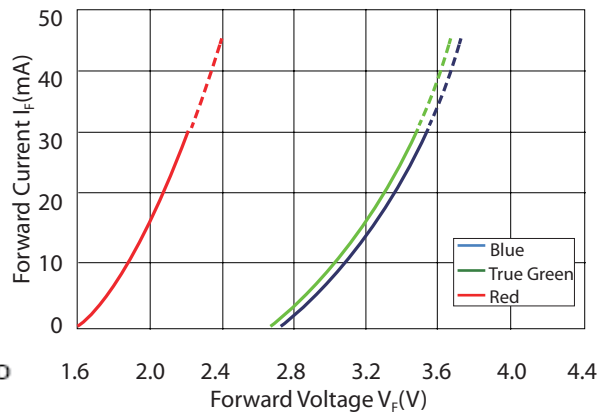
Beam pattern diagram for PLCC 5050 series

Luminous Flux vs. Forward Current



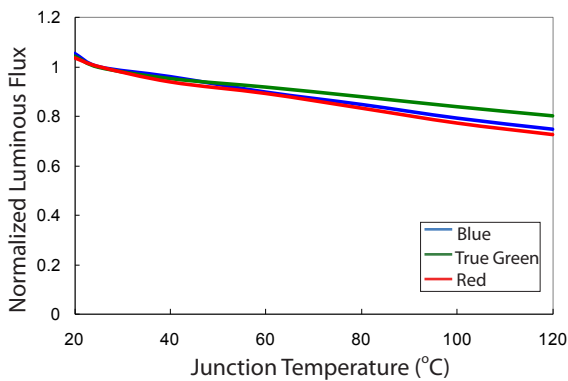
Forward current vs. luminous flux at $T_a = 25^\circ\text{C}$ for PLCC 5050 series

Forward Voltage vs. Forward Current



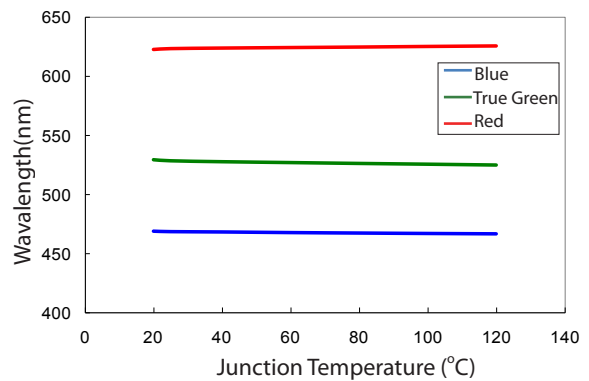
Forward current vs. forward voltage for PLCC 5050 series

Luminous Flux vs. Junction Temperature



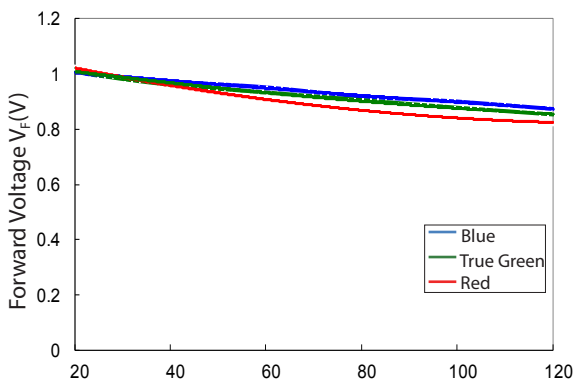
Luminous Intensity vs. Forward Current for PLCC 5050

Wavelength vs. Junction temperature

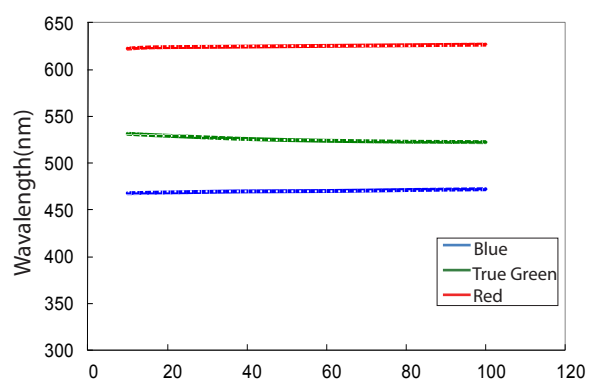


Wavelength vs. Junction Temperature($^\circ\text{C}$) for PLCC 5050

Forward Voltage vs. Junction temperature

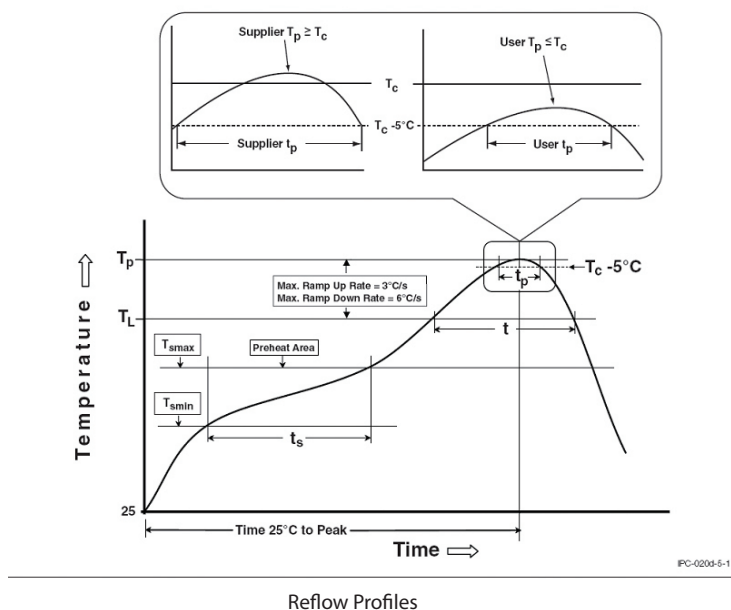


Wavelength vs. Forward Current



Reflow Profile

The following reflow profile is from IPC/JEDEC J-STD-020D which provided here for reference.



Classification Reflow Profiles

Profile Feature	Pb-Free Assembly
Preheat & Soak	150 °C
Temperature min (T _{smin})	200 °C
Temperature max (T _{smax})	60-120 seconds
Time (T _{smin} to T _{smax}) (t _s)	
Average ramp-up rate (T _{smax} to T _p)	3 °C/second max.
Liquidous temperature (T _L)	217 °C
Time at liquidous (t _L)	60-150 seconds
Peak package body temperature (T _p)*	255 °C ~260 °C *
Classification temperature (T _c)	260 °C
Time (t _p)** within 5 °C of the specified classification temperature (T _c)	30** seconds
Average ramp-down rate (T _p to T _{smax})	6°C/second max.
Time 25°C to peak temperature	8 minutes max.

Notes:

- * Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.
- ** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

Reliability

NO .	Test Item	Test Condition	Remark
1	Temperature Cycle	-40°C~100°C 30, 30, mins	100 Cycle
2	Thermal Shock	-40°C~100°C 15, 15 mins ≤ 10 sec	100 Cycle
3	Resistance to Soldering Heat	T _{SOL} =260°C, 30 sec	3 times
4	Moisture Resistance	25°C~65°C 90% RH 24 hrs / 1 cycle	10 Cycle
5	High-Temperature Storage	T _A =100°C	1,000 hrs
6	Humidity Heat Storage	T _A =85°C RH=85%	1,000 hrs
7	Low-Temperature Storage	T _A =-40°C	1,000 hrs
8	Operation Life test	25°C	1,000 hrs
9	High Temperature Operation Life test	85°C	1,000 hrs
10	High Humidity Heat Life Test	85°C, 85%RH	1,000 hrs
11	ON/OFF Test	30 sec ON, 30 sec OFF	1.5W times

Failure Criteria

Item	Criteria for Judgment	
	Min.	Max.
Lumen Maintenance	85%	-
$\Delta u'v'$	-	0.006
Forward Voltage	-	Initial Data x 1.1
Reverse Current	-	10 μ A
Resistance to Soldering Heat	No dead lamps or visual damage	

Product Packaging Information

